

Telink Semiconductor (Shanghai) Co., Ltd.

(date)2023/12/25

Federal Communications Commission  
Authorization and Evaluation Division  
7435 Oakland Mills Road  
Columbia, MD 21046  
USA

RE: Attestation Statements Part 2.911(d)(5)(i) request for  
(FCCID:OEOTLSRSOCSG80R-1)

[Telink Semiconductor (Shanghai) Co., Ltd.] (“the applicant”) certifies that the equipment for which authorization is sought is not “covered” equipment prohibited from receiving an equipment authorization pursuant to section 2.903 of the FCC rules.

Sincerely,

A handwritten signature in black ink that reads "Xiang Li". The signature is written in a cursive, slightly slanted style.

(Applicant signature)

(Applicant printed name):Xiang Li

Telink Semiconductor (Shanghai) Co., Ltd.

(date)2023/12/25

Eurofins Electrical and Electronic Testing NA, Inc.  
914 West Patapsco Avenue  
Baltimore, MD 21230

RE: Attestation Statements Part 2.911(d)(5)(ii) request for  
(FCCID:OEOTLSRSOC80R-1)

[Telink Semiconductor (Shanghai) Co., Ltd.] (“the applicant”) certifies that, as of the date of the filing of the application, the applicant is not identified on the Covered List as an entity producing “covered” equipment.

Sincerely,

*Xiang Li*

(Applicant signature)

(Applicant printed name):Xiang Li